TOSHIBA Field Effect Transistor $\,$ Silicon N Channel MOS Type ($L^2-\pi$ -MOSVI)

2SK2964

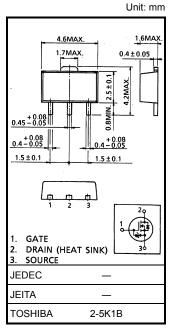
Chopper Regulator, DC-DC Converter and Motor Drive Applications

• 4-V gate drive

 $\begin{array}{ll} \bullet & Low\ drain-source\ ON\ resistance & : R_{DS}\ (ON) = 0.13\ \Omega\ (typ.) \\ \bullet & High\ forward\ transfer\ admittance & : |Y_{fs}| = 2.5\ S\ (typ.) \\ \bullet & Low\ leakage\ current & : I_{DSS} = 100\ \mu A\ (max)\ (V_{DS} = 30\ V) \\ \bullet & Enhancement\ mode & : V_{th} = 0.8 \\ \sim 2.0\ V\ (V_{DS} = 10\ V,\ I_{D} = 1\ mA) \end{array}$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	30	V	
Drain-gate voltage (R _{GS} = 20 kΩ)		V_{DGR}	30	٧	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	I _D	2	Α	
Brain carrent	Pulse (Note 1)	I _{DP}	6	Α	
Drain power dissipation	١	P_{D}	0.5	W	
Drain power dissipation (Note 2)		P_{D}	1.5	W	
Single pulse avalanche energy (Note 3)		E _{AS}	56	mJ	
Avalanche current		I _{AR}	2	Α	
Repetitive avalanche energy (Note 4)		E _{AR}	0.05	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	



Weight: 0.05 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient	R _{th (ch-a)}	250	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: Mounted on a ceramic substrate (25.4 mm × 25.4 mm × 0.8 mm)

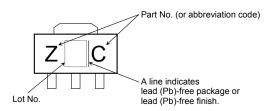
Note 3: V_{DD} = 25 V, T_{ch} = 25°C (initial), L = 10 mH, R_G = 25 Ω , I_{AR} = 2 A

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.

Marking

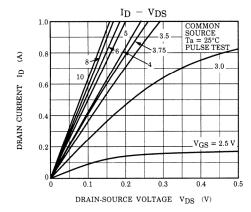


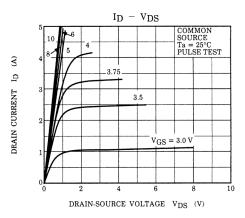
Electrical Characteristics (Ta = 25°C)

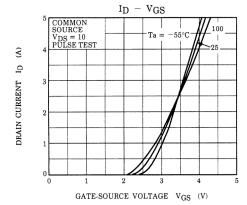
Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cut-off cu	rrent	IDSS	V _{DS} = 30 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source br	eakdown voltage	V _{(BR) DSS}	I _D = 10 mA, V _{GS} = 0 V	30	_	_	V
Gate threshold v	/oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	0.8	_	2.0	V
Drain-source ON resistance		R _{DS (ON)}	V _{GS} = 4 V, I _D = 1 A	_	0.18	0.25	Ω
			V _{GS} = 10 V, I _D = 1 A	_	0.13	0.18	
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 1 A	1.2	2.5	_	S
Input capacitano	ce	C _{iss}		_	140	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	30	_	pF
Output capacitance		C _{oss}			80	_	
Switching time	Rise time	t _r	V_{GS} V_{OV} V_{OUT} V_{OUT} V_{DD} V_{DD}	_	10	_	
	Turn-on time	ton		_	15	_	
	Fall time	t _f		_	85	_	ns ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\rm W} = 10 \mu \rm s$	_	195	_	
Total gate charge (gate-source plus gate-drain)		Qg		_	5.8	_	
Gate-source charge		Q _{gs}	V _{DD} ≈ 24 V, V _{GS} = 10 V, I _D = 2 A		4.3	_	nC
Gate-drain ("miller") Charge		Q _{gd}			1.5	_	

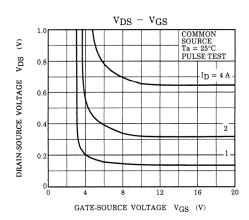
Source-Drain Ratings and Characteristics (Ta = 25°C)

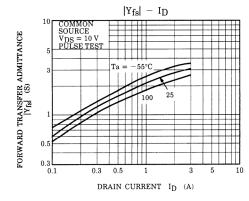
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	2	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	6	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 2 A, V _{GS} = 0 V	_	_	-1.5	V
Reverse recovery time	t _{rr}	IDR = 2 A, VGS = 0 V, dIDR / dt = 50 A / µs	_	50	_	ns
Reverse recovery charge	Qrr	IDR - 2 A, VGS - 0 V, αIDR / αι - 50 A / μS	_	20	_	nC

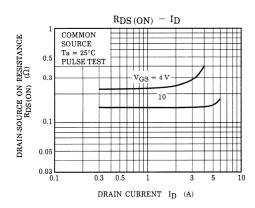




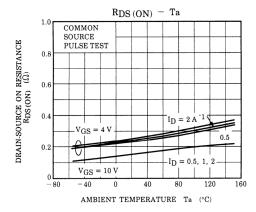


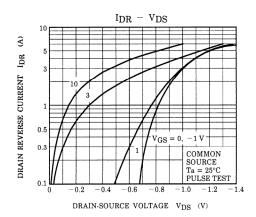


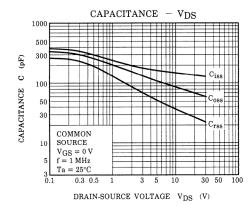


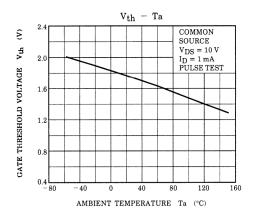


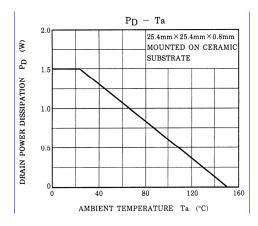
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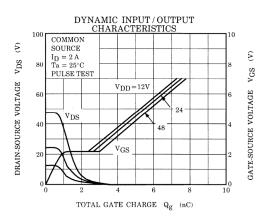




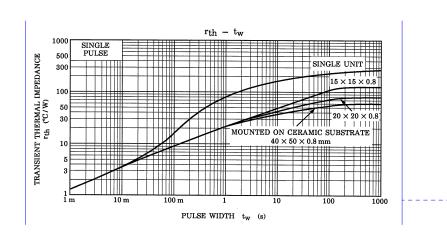




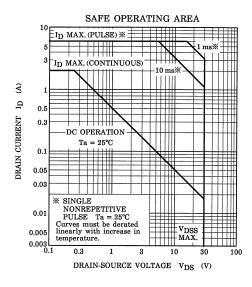


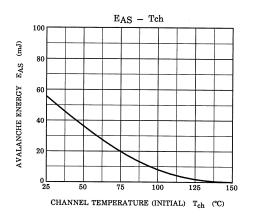


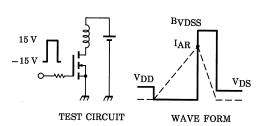
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コメント [H2]: Mounted on a ceramic sbstrate a が抜けています。







$$R_G = 25 \Omega$$

 $V_{DD} = 25 V$, $L = 10 mH$ E_{AS}

5

$$EAS = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{BVDSS}{BVDSS - VDD} \right)$$

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20070701-EN

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